

# Diode radiation tests, setup and first results

- Background / Motivation
- Test requirements
- Test setup & Measurement procedure
- Status & preliminary results
- Outlook

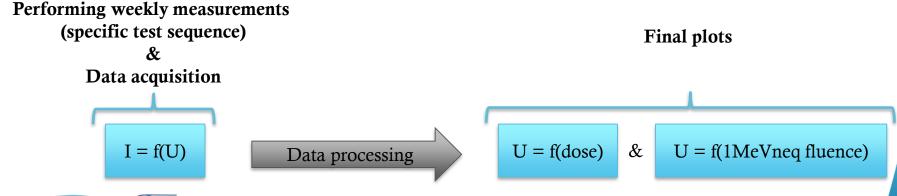
Arnaud Monteuuis for TE-MPE-EE



#### Introduction

- **Subject**: Following TCC recommendation (meeting #29, May 2017), the option of using **cold by-pass diode** in order to protect the **HL-LHC Inner Triplets** in case of **quench** has been studied, the project started in **September 2017**.
- **Purpose**: In order to select the **future potential diodes** which could be used during the **whole operation time** of HL-LHC and in order to be sure that they will be **reliable** during this time, a **dedicated test setup** has been **designed** and **built**.
- This test setup, located at **CHARM**, allows to **characterise** diodes @ **4.2K** and @ **77K** up to **18kA** with a **particle spectrum representative** of their future location in the **Inner Triplets area** (~ **30kGy** (**dose**) and ~ **2.10**<sup>14</sup>**n.cm**<sup>-2</sup> (**1MeVneq fluence**)).

  See slides by Y. Leclercq (location) G. Lerner (expected radiation levels)
- This characterisation consists of following the **evolution** of the diode **electrical parameters** (forward voltage, turn-on voltage, reverse blocking voltage, capacitance) as a function of **radiation** (dose & 1MeVneq fluence). To sum up for forward, turn-on and reverse blocking voltage:

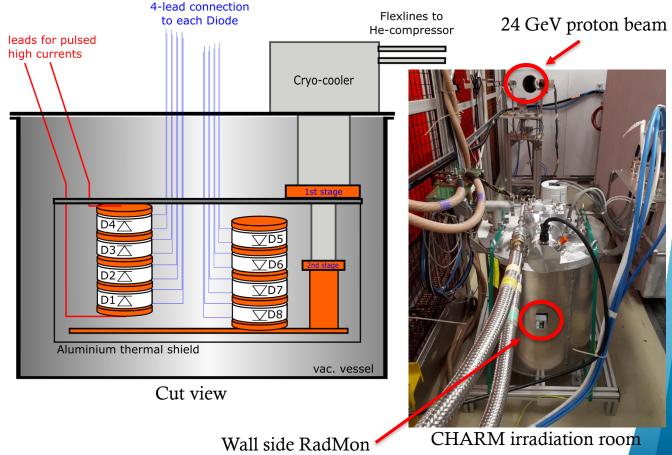


## Cryostat

- diode stacks (4.2K & 77K): 2 LHC, 2 thin base, 4 very thin base diodes, temperature sensors, heaters ...
- **Designed** by ourselves and **installed** at a specific test position inside the **CHARM** (Cern High energy AcceleRator Mixed field facility) irradiation room: Particle spectrum representative of the HL-LHC Inner triplets area and fast dose, fluence accumulation (Fluka factors calculated by A. Infantino with R2E & RP teams).
- Radiation Monitors (RadMons) data are calibrated data scaled with the protons-on-target (PoT).





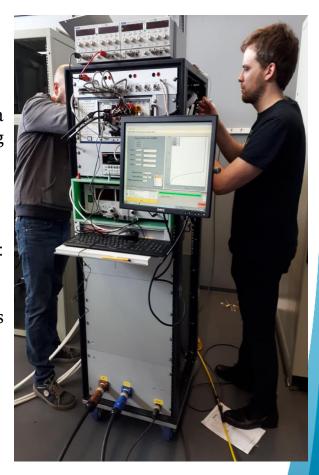


### I. Rack

A test bench, built from scratch by ourselves, containing all the electronic systems needed for the weekly measurements. Installed in the CHARM control room (safe from a radiation point of view).

#### Several purposes:

- To measure different diode electrical parameters ( $U_f$ ,  $U_{to}$ ,  $U_r$ ) as a function of current: I = f(U), and display the corresponding characteristics.
- To monitor and control the temperatures (4.2K & 77K).
- To store data (measurements with the different parameters: **temperature**, **diode type**, ...) in a database.
- To control high voltage power supply, as the high current pulses require 1kV on capacitor bank.



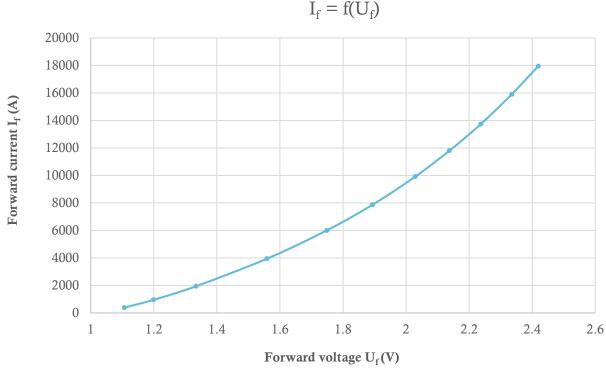


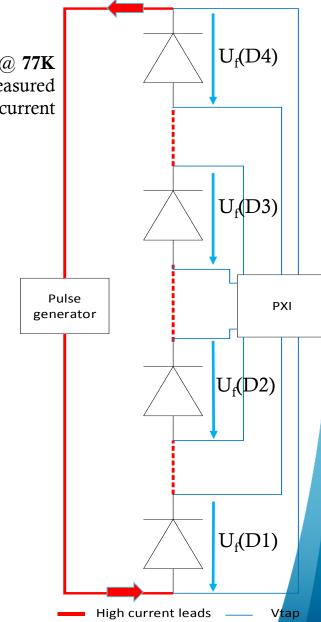


## II. $I_f = f(U_f)$ forward characteristic @ 77K

A high current pulse  $I_f$  is sent from the pulse generator to the 4 diodes @ 77K (connected in series). At the same time, thanks to PXI, we measured individually the voltage drop U<sub>f</sub> of each diode at the peak of the high current pulse (i.e.  $dI_f/dt=0$ ).

500A, 1, 2, 4, 6, 8, 10, 12, 14, 16, 18kA.



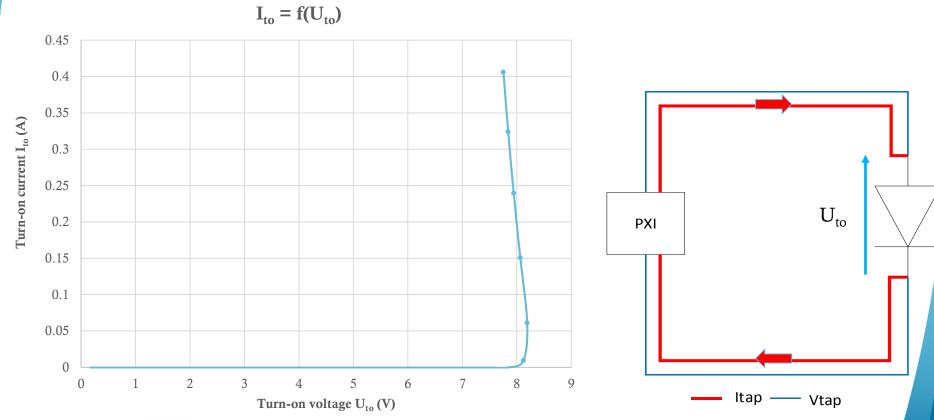






# II. $I_{to} = f(U_{to})$ turn-on characteristic @ 4.2K & 77K

The turn-on voltage,  $U_{to}$ , is measured @ 4.2K & 77K by generating a **voltage ramp** with a fast enough rise rate (100 V/s) on **each diode individually** and measuring the **voltage drop** across it, i.e. the current  $I_{to}$ .







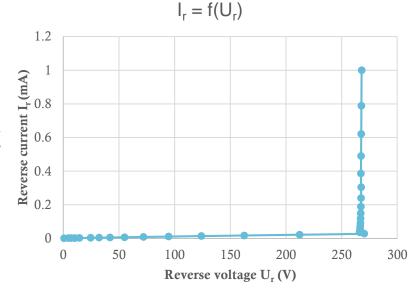
### II. Reverse blocking voltage & Capacitance @ 4.2K & 77K

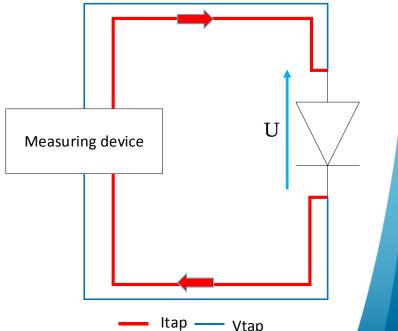
#### Reverse blocking voltage

- A current I<sub>r</sub> generated by the "Keithley 2410 Source Measure Unit" is sent to one diode and we measured the voltage U<sub>r</sub> on this diode at the same time. These measurements are done for the 8 diodes, @ 4.2K & 77K.
- The measuring device communicates with **PXI** (GPIB) and is controlled by a **LabVIEW** software.
- Logarithmic sweep from about 1μA up to 1mA.

#### Capacitance

• The measurements are performed using a **LCR meter**. This device generates an excitation voltage (amplitude = 250mV & f = 1kHz) below conducting threshold voltage (= 300mV) at room temperature.

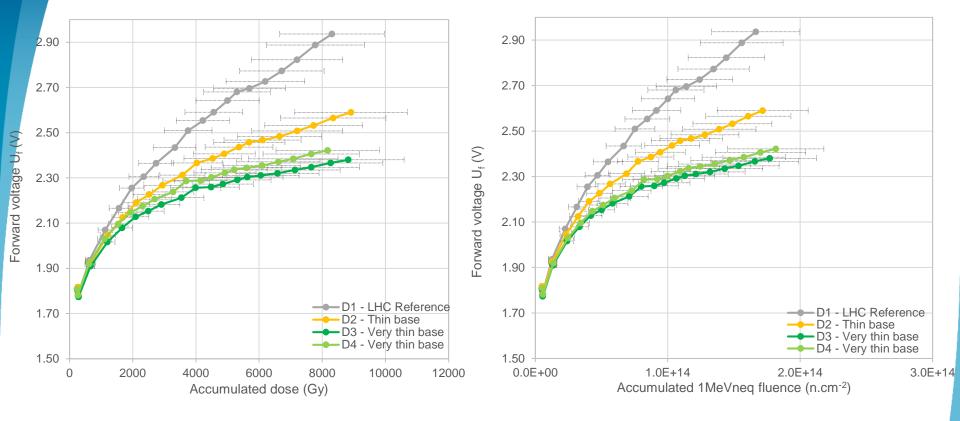








### III. Forward plots @ 77K, 18kA



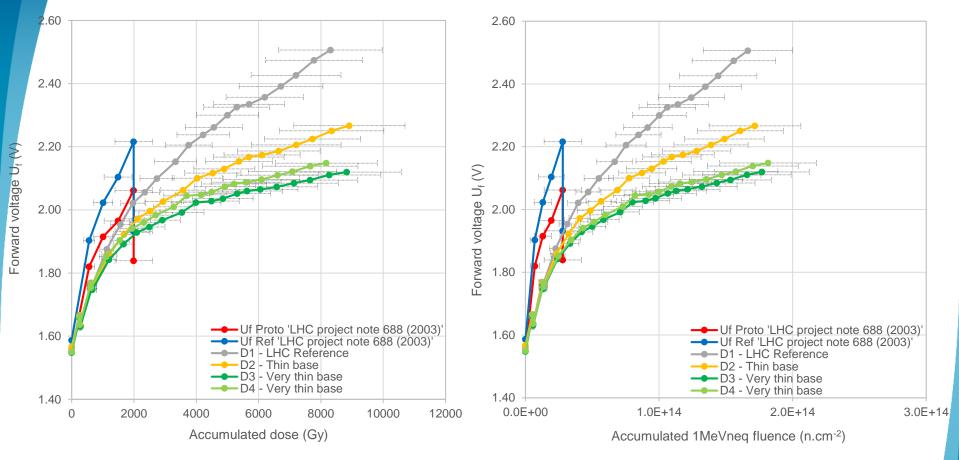
- Forward voltage U<sub>f</sub> increases due to radiation: Radiation introduce defects in the structure of the silicon wafer. Due to the correlation between radiation tolerance and base width, from the most to the least impacted by radiations: D1>D2>D4>D3.
- Last measurements have been done during the **previous week**. Measurements until **November 11<sup>th</sup>**, **2018** (end of the 2018 CHARM irradiation campaign): ~ **10kGy** (dose) and ~ **2.10<sup>14</sup>n.cm**<sup>-2</sup> (1MeVneq fluence).

**Dose** and **1MeVneq fluence** data have been simulated thanks to **FLUKA** (+/- 20%) based on Protons-on-Target (PoT).





### III. Forward plots @ 77K, 12kA

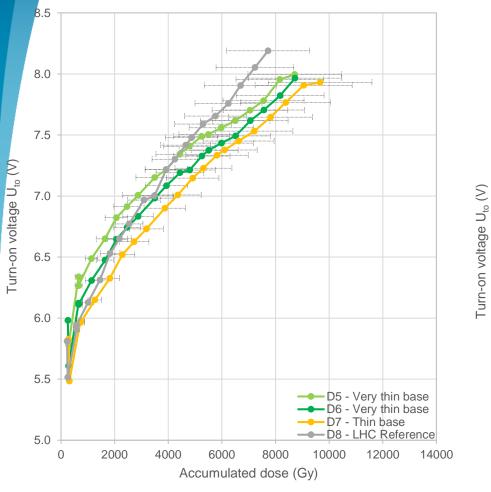


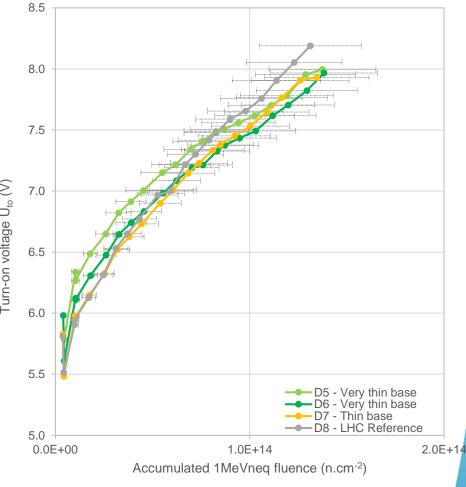
• Forward voltage U<sub>f</sub> differences between our results (CHARM) and the other results (TCC2) can be mainly explained by test setup and dosimetry accuracy (+/- 30% for dose, +/- 50% fluence) differences.





# III. Turn-on plots @ <u>4.2K</u> & 77K

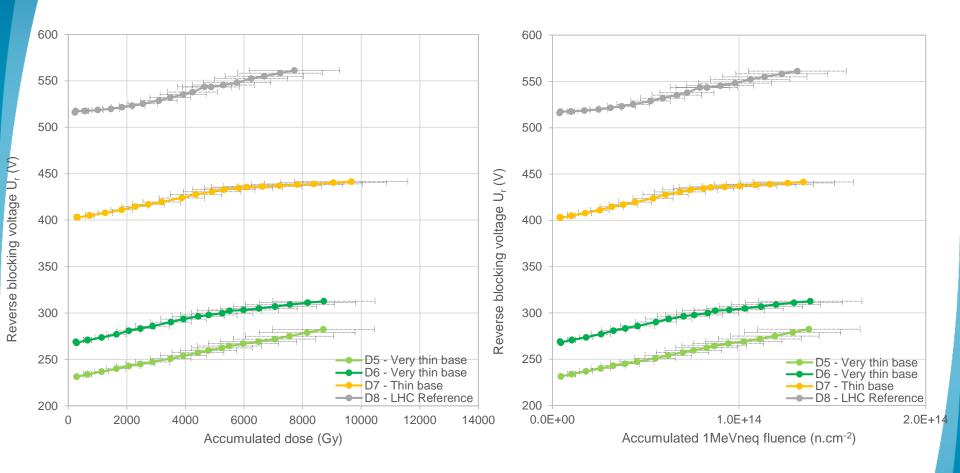








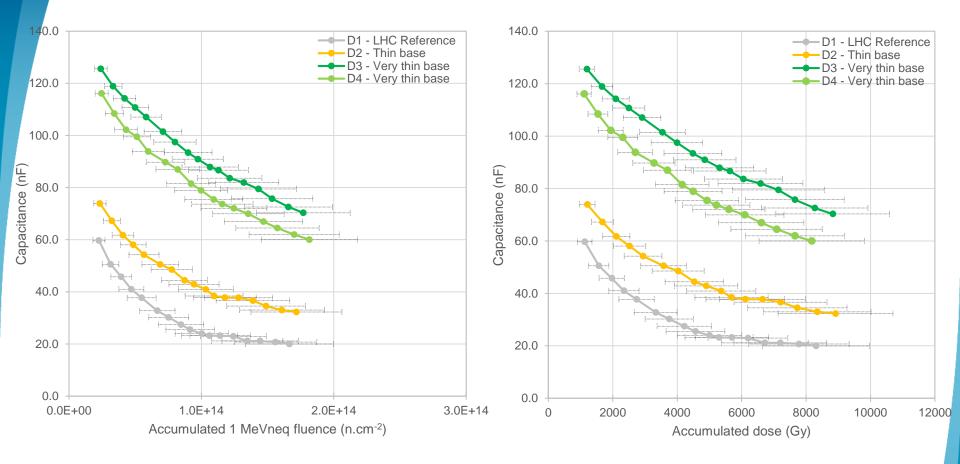
# III. Reverse plots @ 4.2K & 77K







### III. Capacitance plots @ 4.2K & 77K



- Capacitance **decreases** with radiation. Since capacitance **is inversely proportional** to the base width: From the **lowest** to the **highest** capacitance: **D1>D2>D4>D3**.
- Capacitance measurements @ 4.2K didn't vary in 4 months. It can be explained by a **very low carriers mobility** due to the very low temperature or by **diodes already saturated** when we began these measurements.





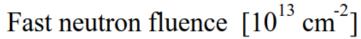
### **Outlook**

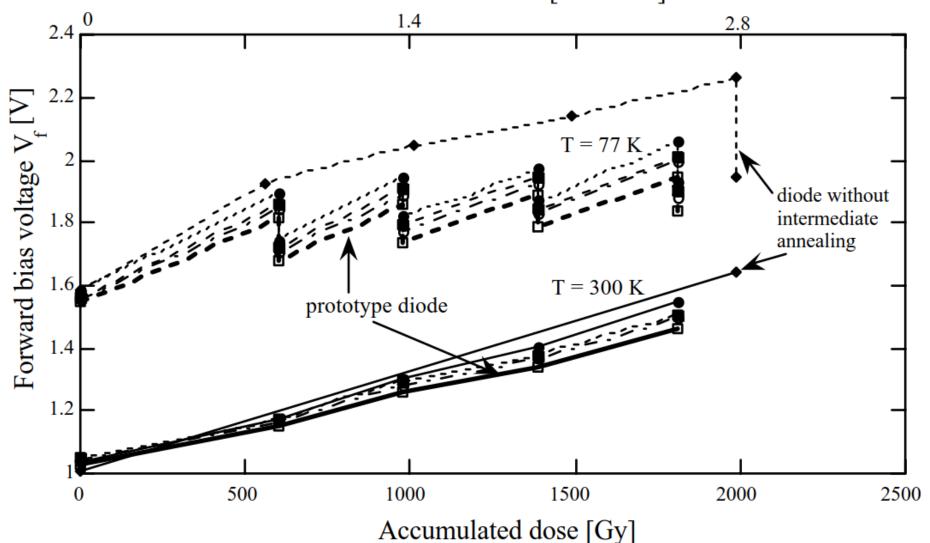
- Forward voltage
  Turn-on voltage
  Reverse blocking voltage
  Capacitance
- 1. Used as a measurement of radiation degradation for the diodes @ 4.2K or 77K.
- 2. Differences as a function of base width.
- → According to the results, **very thin base diodes**: best applicants for the cold by-pass diodes.
- **2. Characterisation** (still in progress until the November 11<sup>th</sup>) of very thin base diodes for HL-LHC Inner Triplets:
  - $\sim$  2.10<sup>14</sup>n.cm<sup>-2</sup> (1MeVneq fluence).
  - × ~ 10kGy instead of 30kGy (dose).
- → Dose & fluence data: Semi-theoretical (Fluka) and experimental (radiation monitors) values are in a good agreement (roughly factor 2).
- 3. Forthcoming tasks:
  - a) Studying the **Annealing effect due to temperature** (after November 11<sup>th</sup>).
  - **b)** To further the dose characterisation: Up to 30kGy by using the same diodes or using other diodes (same production series).

#### Acknowledgements

- Working team (G. D'Angelo, S. Deleage, R. Denz, M. Favre, D. Hagedorn, F. Rodriguez Mateos, A. Siemko, K. Stachon, L. Vammen Kistrup, A. Will, D. Wollmann).
- Radiation To Electronics (R2E)/Fluka (R. García Alía, A. Infantino, M. Krawina, ...).
  - **CHARM activities** (C. Cangialosi, S. Danzeca, J. Lendaro, ...).
  - TE-VSC group.





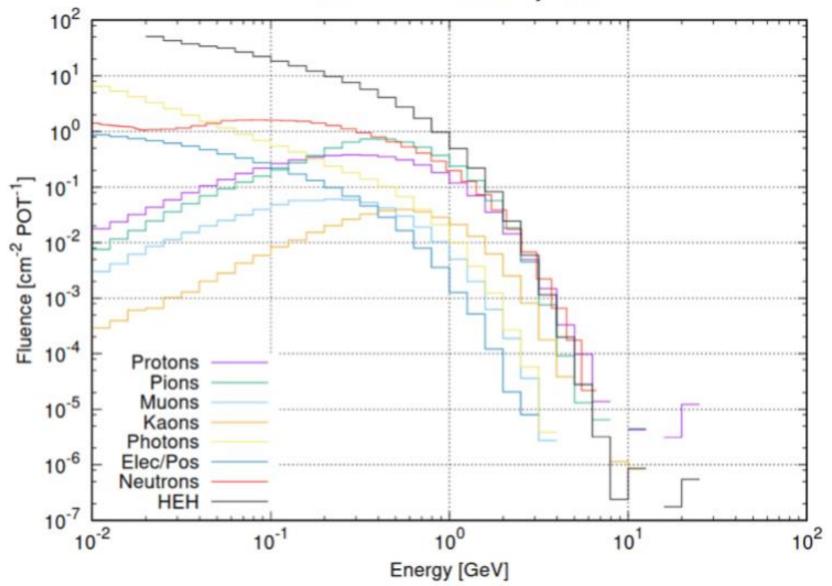


Project report 688 (2003), R. Denz, A. Gharib, D. Hagedorn.



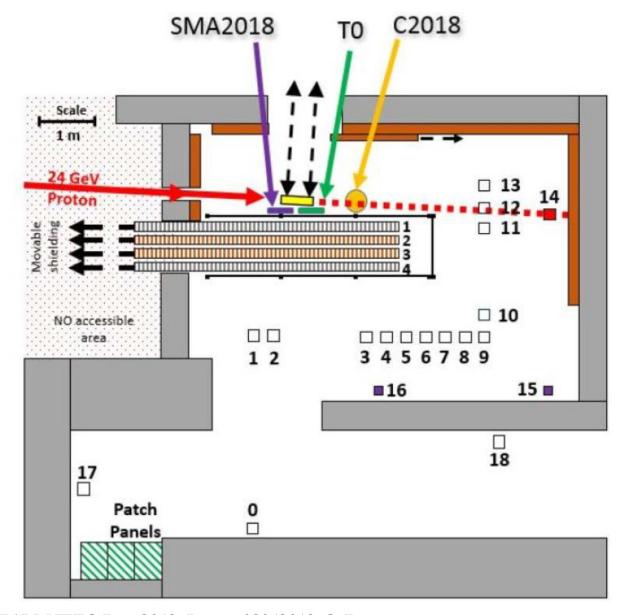


#### Particle fluence within the cryocooler













Target

Target configuration

AlH - Aluminium Hole

- Aluminium

Movable shielding:

III 1 - Concrete

4 - Concrete

2 - Iron 3 - Iron

NT - Empty

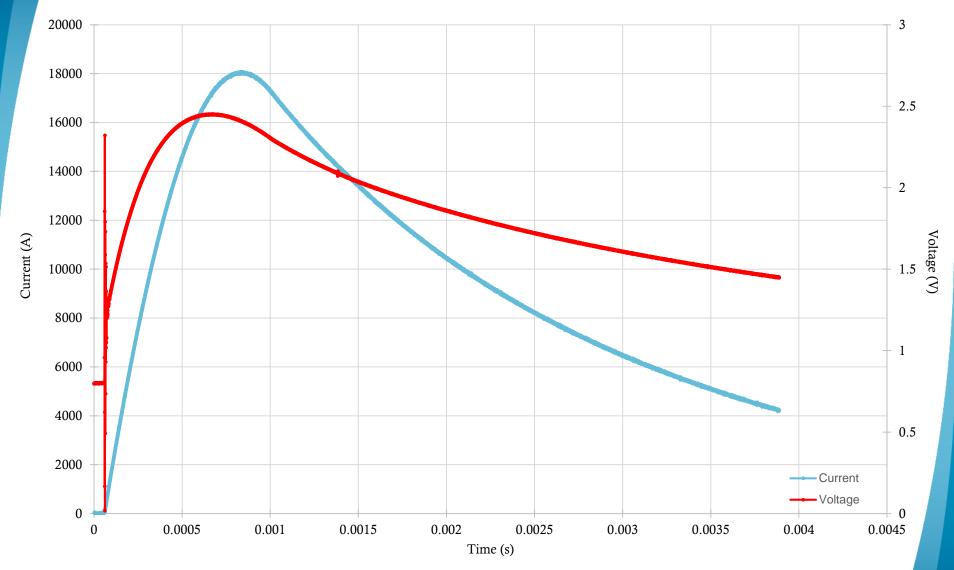
Cu - Copper

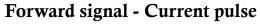
TO Table

Table with SMA

Cryoccoler (C2018)

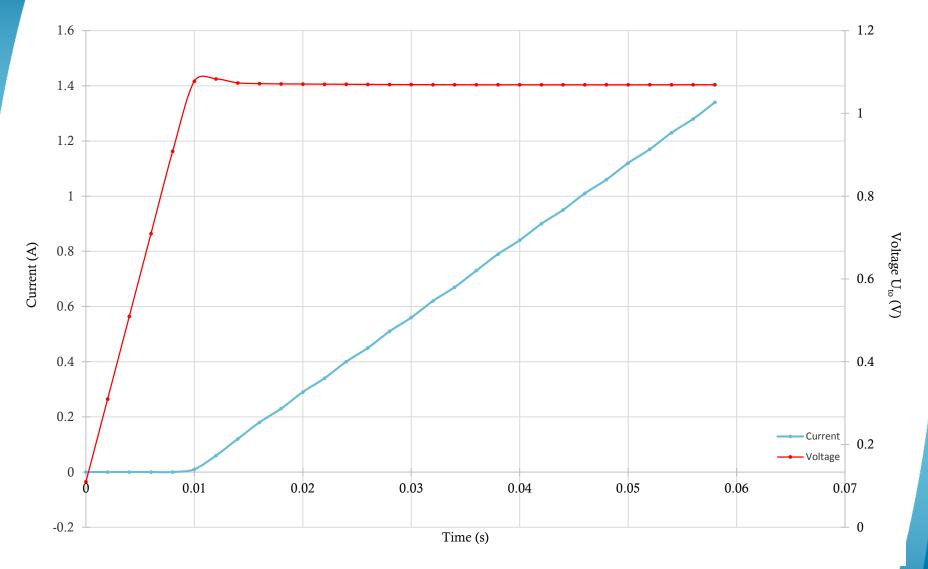
CHARM IEFC June 2018, Report 08062018, S. Danzeca.







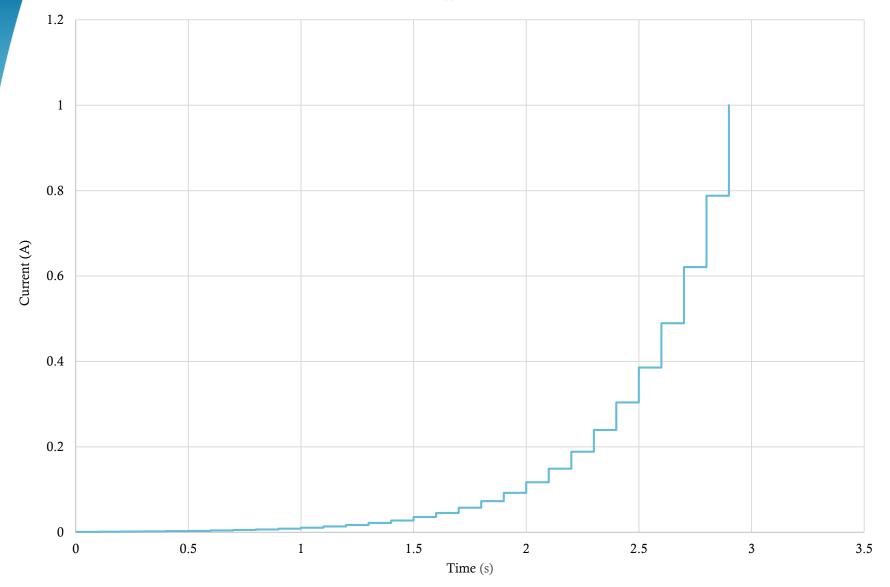




Turn-on signal – Linear voltage ramp







Reverse signal - Logarithmic sweep



